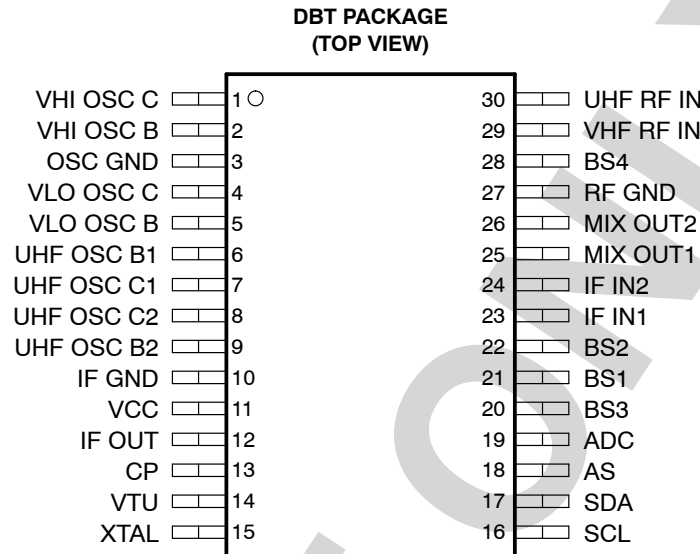


- Single Chip Mixer/Oscillator and Synthesizer
- 3-Band Local Oscillator
- I<sup>2</sup>C Bus Protocol
- Bidirectional Data Transmission
- 30-V Tuning Voltage Output
- 4-Channel NPN-Type Bandswitch Drivers
- Programmable Reference Divider Ratio (512, 640, or 1024)
- 5-V Power Supply
- 30-Pin TSSOP Package



## description

The SN761678 is a single-chip, synthesized tuner IC designed for TV/VCR tuning systems. The circuit consists of a PLL synthesizer, 3-band local oscillators and mixer, 30-V output tuning amplifier, four NPN band switch drivers, and is available in a small package outline. Fifteen-bit programmable counter and reference divider is controlled by I<sup>2</sup>C bus protocol. Tuning step frequency is selectable by this reference divider ratio for a 4-MHz XTAL oscillator.

**NOTE:** The products, their specifications, service and other information appearing in this publication are subjected to change by Texas Instruments without notice.



This device has limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

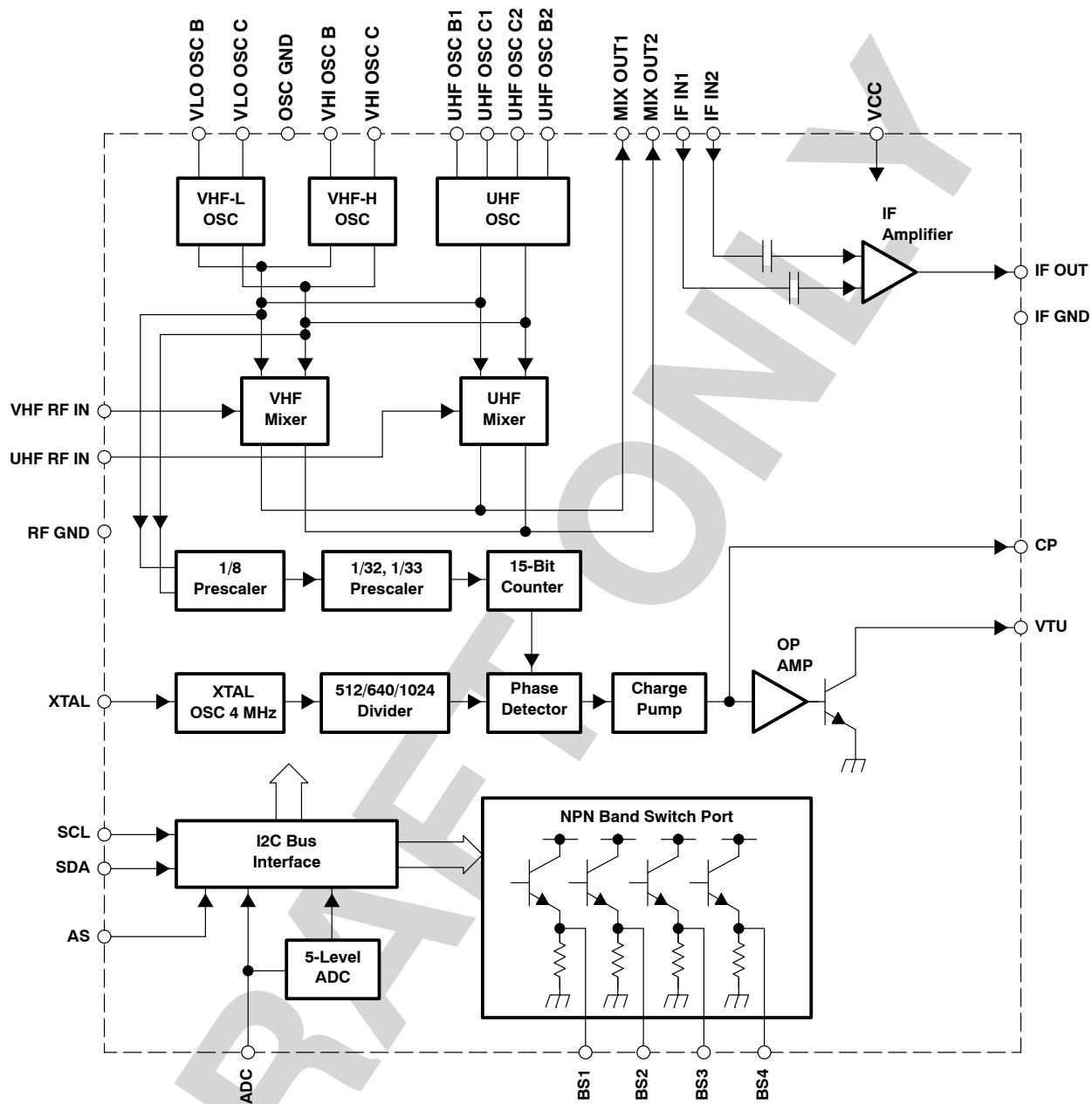


Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

# SN761678 TV/VCR TUNER

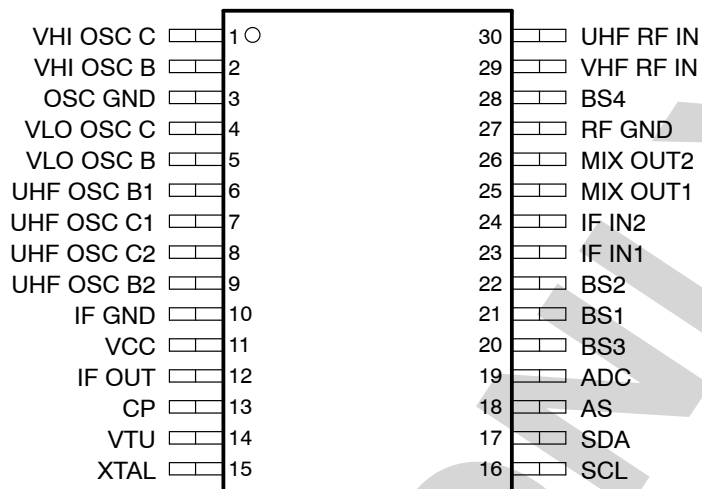
SLES104 – DECEMBER 2003

## functional block diagram



**pin assignments**

**DBT PACKAGE**  
**(TOP VIEW)**



DRAFT ONLY

**Terminal Functions**

Table 1 provides a cross-reference between the terminal number and the signal name.

**Table 1. Signal Names Sorted by DBT Terminal Number**

TERMINAL		DESCRIPTION	SCHEMATIC
NUMBER	SIGNAL NAME		
1	VHI OSC C	VHF HIGH oscillator collector	See Figure 1
2	VHI OSC B	VHF HIGH oscillator base	See Figure 1
3	OSC GND	OSC ground	
4	VLO OSC C	VHF LOW oscillator collector	See Figure 2
5	VLO OSC B	VHF LOW oscillator base	See Figure 2
6	UHF OSC B1	UHF oscillator base 1	See Figure 3
7	UHF OSC C1	UHF oscillator collector 1	See Figure 3
8	UHF OSC C2	UHF oscillator collector 2	See Figure 3
9	UHF OSC B2	UHF oscillator base 2	See Figure 3
10	IF GND	IF ground	
11	VCC	Supply voltage for mixer/oscillator/PLL: 5 V	
12	IF OUT	IF output	See Figure 4
13	CP	Charge pump output	See Figure 5
14	VTU	Tuning voltage amplifier output	See Figure 5
15	XTAL	4-MHz crystal oscillator input	See Figure 6
16	SCL	Serial data input/output	See Figure 7
17	SDA	Serial clock input	See Figure 7
18	AS	Address selection input	See Figure 7
19	ADC	ADC input	See Figure 7
20	BS3 (FMST)	Bandswitch 1 output/FM (NPN emitter follower)	See Figure 8
21	BS1 (VHFL)	Bandswitch 2 output/VHF-LOW (NPN emitter follower)	See Figure 8
22	BS2 (VHFH)	Bandswitch 3 output/VHF-HIGH (NPN emitter follower)	See Figure 8
23	IF IN1	IF amplifier input	See Figure 9
24	IF IN2	IF amplifier input	See Figure 9
25	MIX OUT1	Mixer output	See Figure 10
26	MIX OUT2	Mixer output	See Figure 10
27	RF GND	RF ground	
28	BS4 (UHF)	Bandswitch 4 output/UHF (NPN emitter follower)	See Figure 8
29	VHF RF IN	VHF RF input	See Figure 11
30	UHF RF IN	UHF RF input	See Figure 12

Terminal Functions (continued)

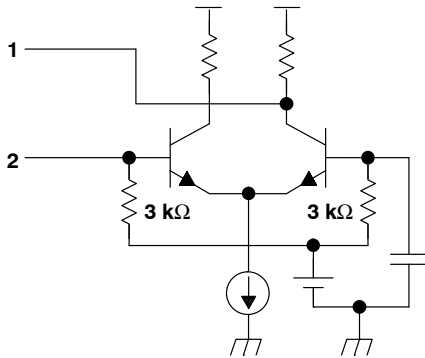


Figure 1

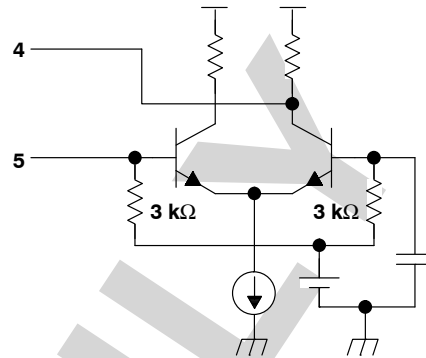


Figure 2

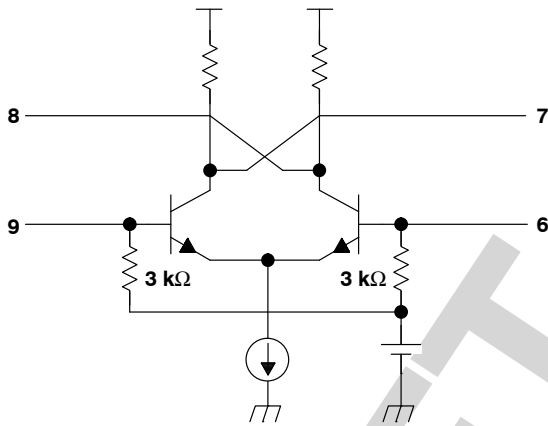


Figure 3

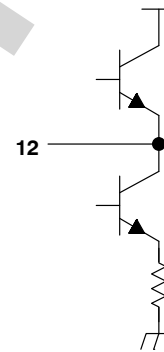


Figure 4

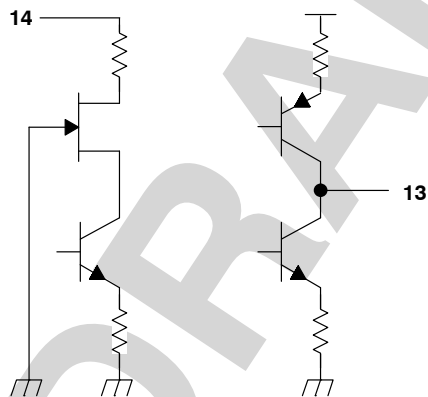


Figure 5

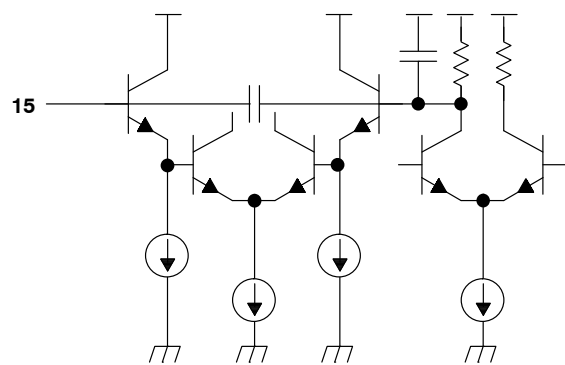
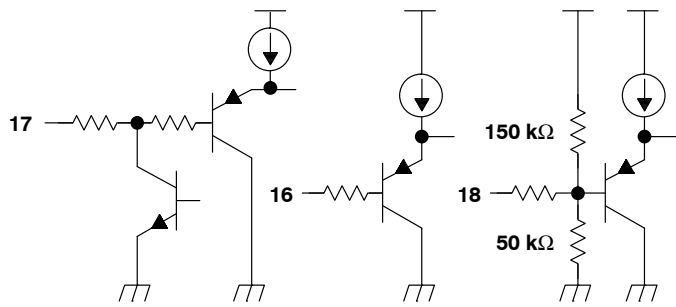
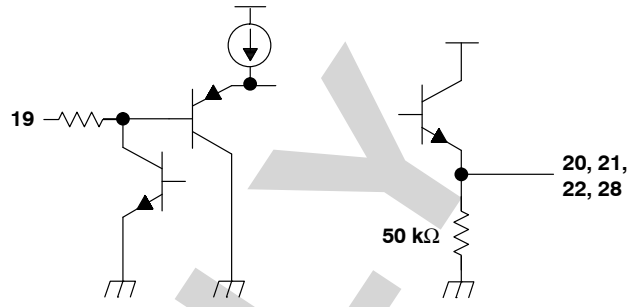


Figure 6

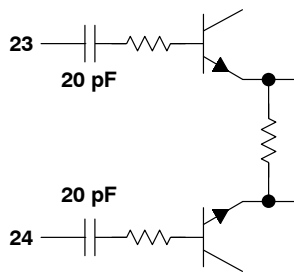
**Terminal Functions (continued)**



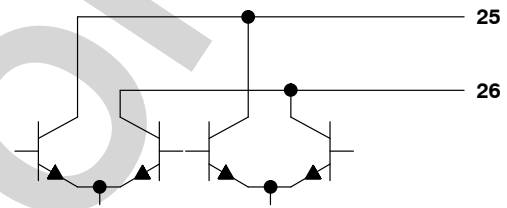
**Figure 7**



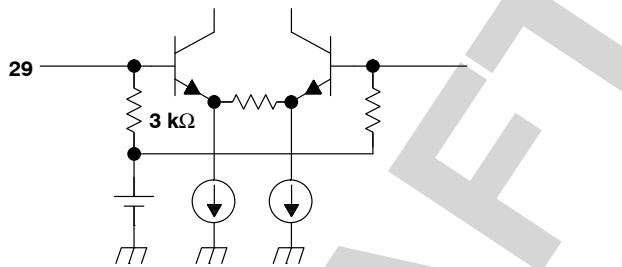
**Figure 8**



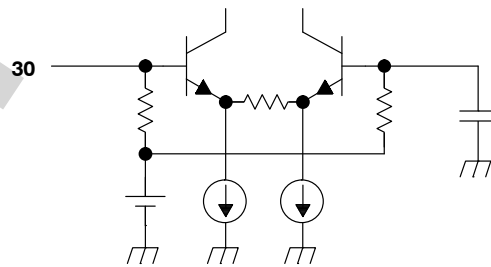
**Figure 9**



**Figure 10**



**Figure 11**



**Figure 12**

DRAFT

**absolute maximum ratings over operating free-air temperature (unless otherwise noted)<sup>†</sup>**

Supply voltage, $V_{CC}$ (terminal 11) (Note 1)	-0.4 V to 6.5 V
Input voltage 1, $V_{GND}$ (terminals 3 and 27) (Note 1)	-0.4 V to 0.4 V
Input voltage 2, $V_{VTU}$ (terminal 14) (Note 1)	-0.4 V to 35 V
Input voltage 3, $V_{IN}$ (terminals 1, 2, 4–9, 12, 13, 15–26, 28–30) (Note 1)	-0.4 V to 6.5 V
Continuous total power dissipation, $T_A \leq 25^\circ\text{C}$ , $P_D$ (Note 2)	1071 mW
Operating free-air temperature, $T_{OPE}$	-20 to $85^\circ\text{C}$
Storage temperature range, $T_{STG}$	-65 to $150^\circ\text{C}$
Maximum junction temperature, $T_{JC}$	$150^\circ\text{C}$
Maximum lead temperature (1.6 mm (1/16 inch) from case for 10 seconds)	$260^\circ\text{C}$
Maximum short circuit time, $t_{SC(max)}$ (All terminals to $V_{CC}$ . All terminals to IFGND, OSCGND, RFGND except for terminal 26)	10 s

<sup>†</sup> Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. Voltage values are with respect to the IF GND of the circuit.  
2. Derating factor is  $8.57 \text{ mW}/^\circ\text{C}$  for  $T_A \leq 25^\circ\text{C}$ .

**recommended operating conditions**

PARAMETER		CONDITIONS	MIN	TYP	MAX	UNIT
$V_{CC}$	Supply voltage		4.5	5	5.5	V
$V_{TU}$	Tuning supply voltage			30	33	V
$I_{BS}$	Output current of bandswitch	One port On			10	mA
$T_{OPE}$	Operating free-air temperature		-20		85	$^\circ\text{C}$

**CAUTION:** It is advised that precautions be taken to avoid damage due to high static voltages or electrostatic fields in handling this device.

# SN761678

## TV/VCR TUNER

SLES104 – DECEMBER 2003

### electrical characteristics

#### total device and serial interface

$V_{CC} = 4.5$  to  $5.5$  V,  $T_{OP E} = -20$  to  $85^{\circ}\text{C}$ , unless otherwise noted

PARAMETER		CONDITIONS	MIN	TYP	MAX	UNIT
I <sub>CC1</sub>	Supply current 1			60		mA
I <sub>CC2</sub>	Supply current 2	One band switch On (I <sub>BS</sub> = 10 mA)		70		mA
V <sub>IH</sub>	High level input voltage (SCL, SDA)		2.8		V <sub>CC</sub>	V
V <sub>IL</sub>	Low level input voltage (SCL, SDA)				1.4	V
I <sub>IH</sub>	High level input current (SCL, SDA)				10	μA
I <sub>IL</sub>	Low level input current (SCL, SDA)		-10			μA
V <sub>POR</sub>	Power on reset supply voltage	Threshold of supply voltage between reset and operation mode	2.1	2.8	3.5	V
I2C interface						
V <sub>ASH</sub>	Address select high input voltage (AS)	V <sub>CC</sub> = 5 V	4.5		5.0	V
V <sub>ASM1</sub>	Address select mid1 input voltage (AS)	V <sub>CC</sub> = 5 V	2.0		3.0	V
V <sub>ASM2</sub>	Address select mid2 input voltage (AS)	V <sub>CC</sub> = 5 V	1.0		1.5	V
V <sub>ASL</sub>	Address select low input voltage (AS)	V <sub>CC</sub> = 5 V			0.5	V
I <sub>ASH</sub>	Address select high input current (AS)				120	μA
I <sub>ASL</sub>	Address select low input current (AS)		-10			μA
V <sub>ADC</sub>	ADC input voltage	See Table 9	0		V <sub>CC</sub>	V
I <sub>ADH</sub>	ADC high level input current	V <sub>ADC</sub> = V <sub>CC</sub>			10	μA
I <sub>ADL</sub>	ADC low level input current	V <sub>ADC</sub> = 0 V	-10			μA
F <sub>SCL</sub>	Clock frequency (SCL)			100	400	kHz
V <sub>OL</sub>	Low level output voltage (SDA)	V <sub>CC</sub> = 5 V, I <sub>OL</sub> = 3 mA			0.4	V
I <sub>SDAH</sub>	High level output leakage current (SDA)	V <sub>SDA</sub> = 5.5 V			10	μA
t <sub>HLD-DAT</sub>	Data hold time	See timing chart, Figure 1	0			μs
t <sub>BUF</sub>	Bus free time		1.3			μs
t <sub>HD-STA</sub>	Start hold time		0.6			μs
t <sub>LOW</sub>	SCL low hold time		1.3			μs
t <sub>HIGH</sub>	SCL high hold time		0.6			μs
t <sub>SU-STA</sub>	Start setup time		0.6			μs
t <sub>SU-DAT</sub>	Data setup time		0.1			μs
t <sub>R</sub>	SCL, SDA rise time				0.3	μs
t <sub>F</sub>	SCL, SDA fall time				0.3	μs
t <sub>ST-STO</sub>	Stop setup time		0.6			μs



**electrical characteristics (continued)**

**PLL and bandswitch**

$V_{CC} = 4.5$  to  $5.5$  V,  $T_{OPE} = -20$  to  $85^{\circ}\text{C}$ , unless otherwise noted

PARAMETER		CONDITION	MIN	TYP	MAX	UNIT
N	Divider ratio	15-bit frequency word	256		3276 7	
F <sub>XTAL</sub>	Crystal oscillator	R <sub>XTAL</sub> = 25 Ω to 300 Ω	3.2	4	4.48	MHz
Z <sub>XTAL</sub>	Crystal oscillator input impedance			1.6		kΩ
V <sub>I<sub>XTAL2</sub></sub>	Minimum reference input sensitivity (XTAL)	4 MHz, ac coupling with 0.1 μF			100	mVp-p
V <sub>VTUL</sub>	Tuning amplifier low level output voltage	R <sub>L</sub> = 27 kΩ, V <sub>TU</sub> = 33 V	0.2	0.3	0.46	V
I <sub>VTUOFF</sub>	Tuning amplifier leakage current (off)	OS = 1, V <sub>TU</sub> = 33 V			10	μA
I <sub>CPH</sub>	Charge pump high level input current	CP = 1		280		μA
I <sub>CPL</sub>	Charge pump low level input current	CP = 0		60		μA
V <sub>CP</sub>	Charge pump output voltage	In-lock		1.95		V
I <sub>CPOFF</sub>	Charge pump leakage current	T <sub>2</sub> = 0, T <sub>1</sub> = 1, V <sub>CP</sub> = 2 V, T <sub>A</sub> = 25°C	-15		+15	nA
I <sub>BS</sub>	Band switch driver output current				10	mA
V <sub>SBS1</sub>	Band switch driver output voltage	I <sub>BS</sub> = 10 mA	3.0			V
V <sub>SBS2</sub>	Band switch driver output voltage	I <sub>BS</sub> = 10 mA, V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C	3.5	3.9		V
I <sub>BSOFF</sub>	Band switch driver leakage current	V <sub>BS</sub> = 0 V			3	μA

DRAFT

# SN761678 TV/VCR TUNER

SLES104 – DECEMBER 2003

## electrical characteristics (continued)

### mixer, oscillator, IF amplifier

$V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ , measured in reference measurement circuit at 50- $\Omega$  system, IF filter characteristics:  
f<sub>PEAK</sub> = 43 MHz; unless otherwise noted

PARAMETER		CONDITION	MIN	TYP	MAX	UNIT
G <sub>c1</sub> G <sub>c3</sub>	Conversion gain (mixer to IF amplifier) VHF-low	F <sub>in</sub> = 58 MHz (Note 3) F <sub>in</sub> = 130 MHz	22 22	25 25	28 28	dB
G <sub>c4</sub> G <sub>c6</sub>	Conversion gain (mixer to IF amplifier) VHF-high	F <sub>in</sub> = 136 MHz (Note 3) F <sub>in</sub> = 364 MHz	22 22	25 25	28 28	dB
G <sub>c7</sub> G <sub>c9</sub>	Conversion gain (mixer to IF amplifier) VHF-UHF	F <sub>in</sub> = 370 MHz (Note 3) F <sub>in</sub> = 804 MHz	26 25	29 28	32 31	dB
NF <sub>1</sub> NF <sub>3</sub>	Noise figure VHF-low	F <sub>in</sub> = 55.25 MHz F <sub>in</sub> = 127.25 MHz		(9.5) (9.5)		dB
NF <sub>4</sub> NF <sub>6</sub>	Noise figure VHF-high	F <sub>in</sub> = 133.25 MHz F <sub>in</sub> = 361.25 MHz		(10) (10)		dB
NF <sub>7</sub> NF <sub>9</sub>	Noise figure UHF	F <sub>in</sub> = 367.25 MHz F <sub>in</sub> = 801.25 MHz		(11) (11)		dB
CM <sub>1</sub> CM <sub>3</sub>	1% cross modulation distortion VHF-low	F <sub>in</sub> = 55.25 MHz (Note 4) F <sub>in</sub> = 127.25 MHz		(89) (89)		dB $\mu$ V
CM <sub>4</sub> CM <sub>6</sub>	1% cross modulation distortion VHF-high	F <sub>in</sub> = 133.25 MHz (Note 4) F <sub>in</sub> = 361.25 MHz		(86) (86)		dB $\mu$ V
CM <sub>7</sub> CM <sub>9</sub>	1% cross modulation distortion UHF	F <sub>in</sub> = 367.25 MHz (Note 4) F <sub>in</sub> = 801.25 MHz		(87) (87)		dB $\mu$ V
V <sub>IF01</sub> V <sub>IF03</sub>	IF output voltage VHF-low	F <sub>in</sub> = 55.25 MHz (Note 5) F <sub>in</sub> = 127.25 MHz		117 117		dB $\mu$ V
V <sub>IF04</sub> V <sub>IF06</sub>	IF output voltage VHF-high	F <sub>in</sub> = 133.25 MHz (Note 5) F <sub>in</sub> = 361.25 MHz		117 117		dB $\mu$ V
V <sub>IF07</sub> V <sub>IF09</sub>	IF output voltage UHF	F <sub>in</sub> = 367.25 MHz (Note 5) F <sub>in</sub> = 801.25 MHz		117 117		dB $\mu$ V
$\Phi_{OSC1}$ $\Phi_{OSC3}$	Phase noise VHF-low	F <sub>in</sub> = 55.25 MHz (Note 6) F <sub>in</sub> = 127.25 MHz		88 88		dBc/Hz
$\Phi_{OSC4}$ $\Phi_{OSC6}$	Phase noise VHF-high	F <sub>in</sub> = 133.25 MHz (Note 6) F <sub>in</sub> = 361.25 MHz		86 86		dBc/Hz
$\Phi_{OSC7}$ $\Phi_{OSC9}$	Phase noise UHF	F <sub>in</sub> = 367.25 MHz (Note 6) F <sub>in</sub> = 801.25 MHz		84 84		dBc/Hz
Prescaler beat (Note 7)					(25)	dB $\mu$ V

- NOTES: 3. IF = 43 MHz, RF input level = 80 dB $\mu$ V  
 4. F<sub>undes</sub> = F<sub>des</sub> ± 6 MHz, P<sub>in</sub> = 80 dB $\mu$ V, AM 1 kHz, 30%, DES/CM = S/I = 46 dB  
 5. IF = 45.75 MHz  
 6. Offset = 10 kHz, RF input level = 70 dB $\mu$ V  
 7. Design parameter, not tested.

PRINCIPLES OF OPERATION

I<sup>2</sup>C bus mode

(1) I<sup>2</sup>C write mode (R/W = 0)

Table 2. Write Data Format

	MSB						LSB			
Address byte (ADB)	1	1	0	0	0	MA1	MA0	R/W = 0	A	
Divider byte 1 (DB1)	0	N14	N13	N12	N11	N10	N9	N8	A	
Divider byte 2 (DB2)	N7	N6	N5	N4	N3	N2	N1	N0	A	
Control byte (CB)	1	CP	T2	T1	T0	RSA	RSB	OS	A	
Bandswitch byte (BB)	X	X	X	X	BS4	BS3	BS2	BS1	A	

A: Acknowledge

Table 3. Description of Data Symbols

SYMBOL	DESCRIPTION	DEFAULT																
MA1, MA0	Address set bits (see Table 4)																	
N14...N0	Programmable counter set bits $N = N14 \cdot 2^{14} + N13 \cdot 2^{13} + \dots + N1 \cdot 2 + N0$ Oscillation frequency = $fr \times 8 \times N$ $fr$ = reference frequency = 4 MHz / Reference divider	$N_n = 0$																
CP	Charge pump current set bit 60 $\mu$ A (CP = 0) 280 $\mu$ A (CP = 1)	CP = 1																
T2, T1, T0	Test bits (see Table 5) Normal mode: T2 = 0, T1 = 0, T0 = 1/0	T2 = 0, T1 = 0, T0 = 1																
RSA, RSB	Reference divider ratio selection bits (see table 6 reference divider ratio)	RSA = 0, RSB = 1																
OS	Tuning amplifier control bit Tuning voltage on (OS = 0) Tuning voltage off, high impedance (OS = 1)	OS = 0																
BS4...BS1	Band switch ports control bits $BS_n = 0$ : OFF, $BS_n = 1$ : ON Band selection by BS1, 2, 4 (x: don't care)	$BS_n = 0$																
	<table border="1"> <thead> <tr> <th></th> <th>BS1 (VL)</th> <th>BS2 (VH)</th> <th>BS4 (U)</th> </tr> </thead> <tbody> <tr> <td>VHF-LO</td> <td>1</td> <td>0</td> <td>0</td> </tr> <tr> <td>VHF-HI</td> <td>x</td> <td>1</td> <td>0</td> </tr> <tr> <td>UHF</td> <td>x</td> <td>x</td> <td>1</td> </tr> </tbody> </table>		BS1 (VL)	BS2 (VH)	BS4 (U)	VHF-LO	1	0	0	VHF-HI	x	1	0	UHF	x	x	1	
	BS1 (VL)	BS2 (VH)	BS4 (U)															
VHF-LO	1	0	0															
VHF-HI	x	1	0															
UHF	x	x	1															
X	Don't care																	

Table 4. Address Selection

VOLTAGE APPLIED ON AS INPUT	MA1	MA0
Low: 0 V to 0.1 V <sub>CC</sub>	0	0
MID2: Open, or, 0.2 V <sub>CC</sub> to 0.3 V <sub>CC</sub>	0	1
MID1: 0.4 V <sub>CC</sub> to 0.6 V <sub>CC</sub>	1	0
High: 0.9 V <sub>CC</sub> to V <sub>CC</sub>	1	1

**PRINCIPLES OF OPERATION**

**Table 5. Test Bits (Note 8)**

T2	T1	T0	FUNCTION
0	0	0	Normal operation
0	0	1	Normal operation (default)
0	1	X	Charge pump off
1	1	0	Charge pump sink
1	1	1	Charge pump source
1	0	X	Test mode (not available ADC)

NOTE 8: Not used for other bit patterns.

**Table 6. Ratio Select Bits**

RSA	RSB	REFERENCE DIVIDER RATIO
X	0	640
0	1	1024
1	1	512

**(2) I<sup>2</sup>C Read mode (R/W = 1)**

**Table 7. Read Data Format**

	MSB							LSB		
Address byte (ADB)	1	1	0	0	0	MA1	MA0	R/W = 1	A	
Status byte (SB)	POR	FL	1	1	1	A2	A1	A0	A	

A: Acknowledge

**Table 8. Description of Data Symbols**

SYMBOL	DESCRIPTION	DEFAULT
MA1, MA0	Address set bits (see Table 4 address selection)	
POR	Power-on reset flag POR set = power on POR reset = end-of-data transmission procedure	POR = 1
FL	In-lock flag PLL lock (FL = 1) unlock (FL = 0)	
A2...A0	Digital data of ADC (see Table 9)	

**Table 9. ADC Level**

VOLTAGE APPLIED ON ADC INPUT	A2	A1	A0
0.6 V <sub>CC</sub> to V <sub>CC</sub>	1	0	0
0.45 V <sub>CC</sub> to 0.6 V <sub>CC</sub>	0	1	1
0.3 V <sub>CC</sub> to 0.45 V <sub>CC</sub>	0	1	0
0.15 V <sub>CC</sub> to 0.3 V <sub>CC</sub>	0	0	1
0 to 0.15 V <sub>CC</sub>	0	0	0

NOTE 9: Note 9: Accuracy is 0.03 x V<sub>CC</sub>.

PRINCIPLES OF OPERATION

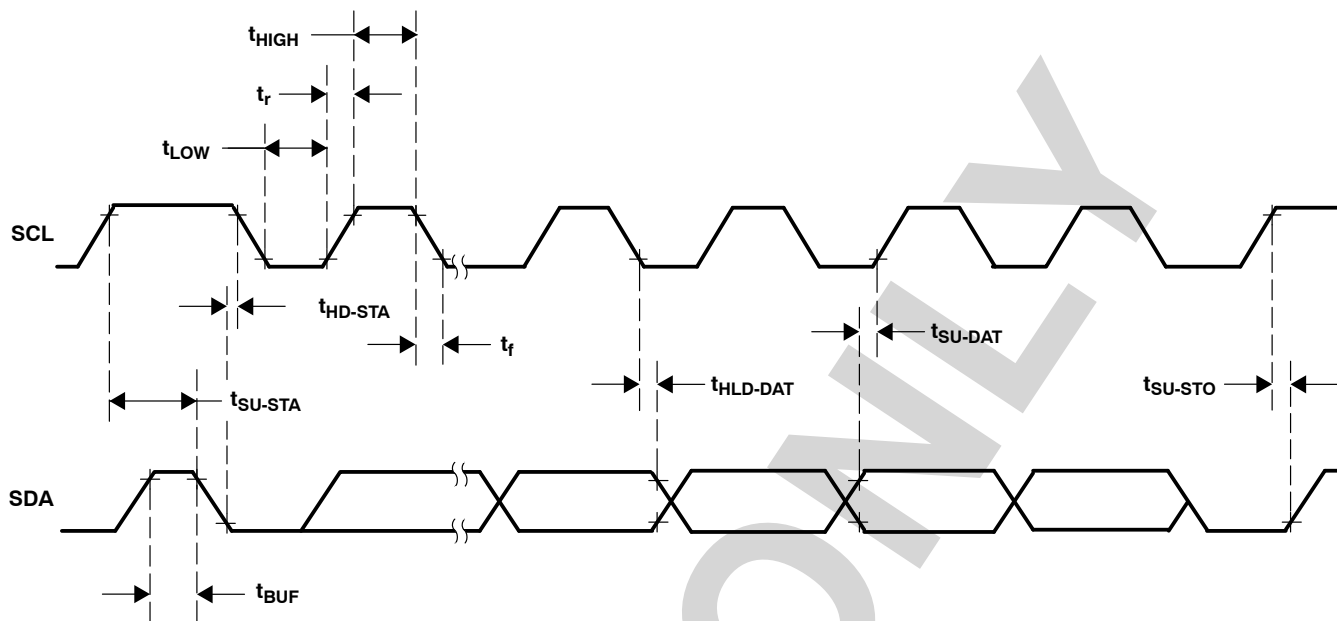
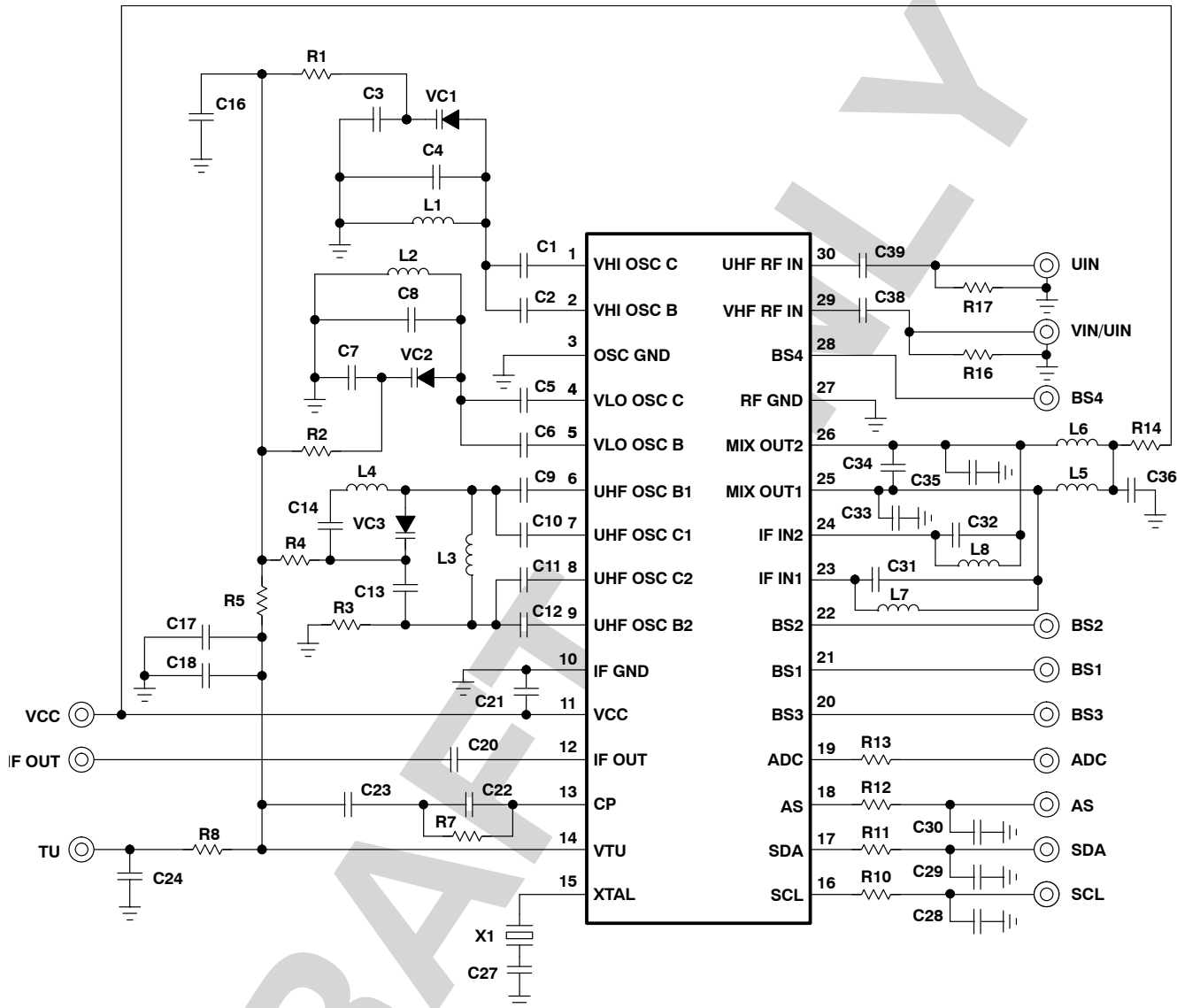


Figure 13. I<sup>2</sup>C Timing Chart

DRAFT

**APPLICATION INFORMATION**

**reference measurement circuit**



**Figure 14. Reference Measurement Circuit**

NOTE 10: This application information is advisory and performance check is required at actual application circuits.

TI assumes no responsibility for the consequences of use of this circuit nor for any infringement of patent or patent rights of third parties which may result from its use.

APPLICATION INFORMATION

component values for measurement circuit

PARTS NAME	VALUE	PARTS NAME	VALUE
U1	SN761678	C1	2 pF
		C2	3 pF
VC1	1T363A	C3	68 pF
VC2	1T363A	C4	open
VC3	1T363A	C5	1 pF
		C6	1 pF
L1	φ2.4mm 4T 0.4mm	C7	47 pF
L2	φ3.0mm 8T 0.32mm	C8	3 pF
L3	φ3.0mm 2T 0.4mm	C9	1.5 pF
L4	φ2.0mm 3T 0.4mm	C10	1.5 pF
L5	φ2.4mm 16T 0.26mm	C11	1.5 pF
L6	φ2.4mm 16T 0.26mm	C12	1.5 pF
L7	open	C13	12 pF
L8	open	C14	100 pF
		C15	-
X1	4 MHz	C16	2.2 nF/50 V
		C17	2.2 nF/50 V
R1	33 kΩ	C18	2.2 nF/50 V
R2	33 kΩ	C19	-
R3	22 kΩ	C20	2.2 nF
R4	33 kΩ	C21	4.7 nF
R5	22 kΩ	C22	2.2 nF
R6	-	C23	0.1 μF/50 V
R7	22 kΩ	C24	2.2 nF/50 V
R8	22 kΩ	C25	-
R9	-	C26	-
R10	330 Ω	C27	68 pF
R11	330 Ω	C28	open
R12	330 Ω	C29	open
R13	short	C30	open
R14	short	C31	short
R15	-	C32	short
R16	open	C33	open
R17	open	C34	22 pF
		C35	open
		C36	4.7 nF
		C37	-
		C38	2.2 nF
		C39	2.2 nF

APPLICATION INFORMATION

test circuit

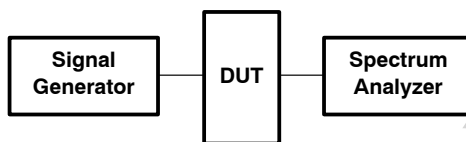


Figure 15. Measurement Circuit of Conversion Gain

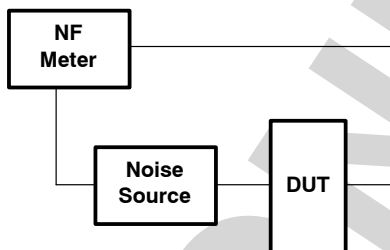


Figure 16. Noise Figure Measurement Circuit

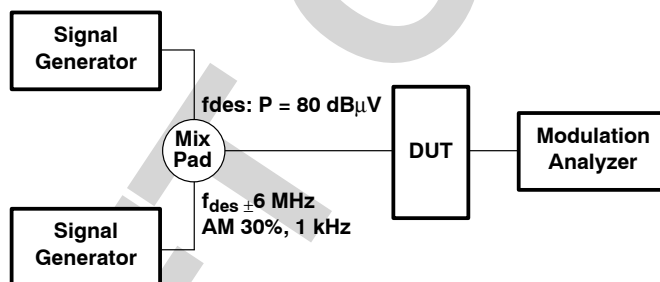


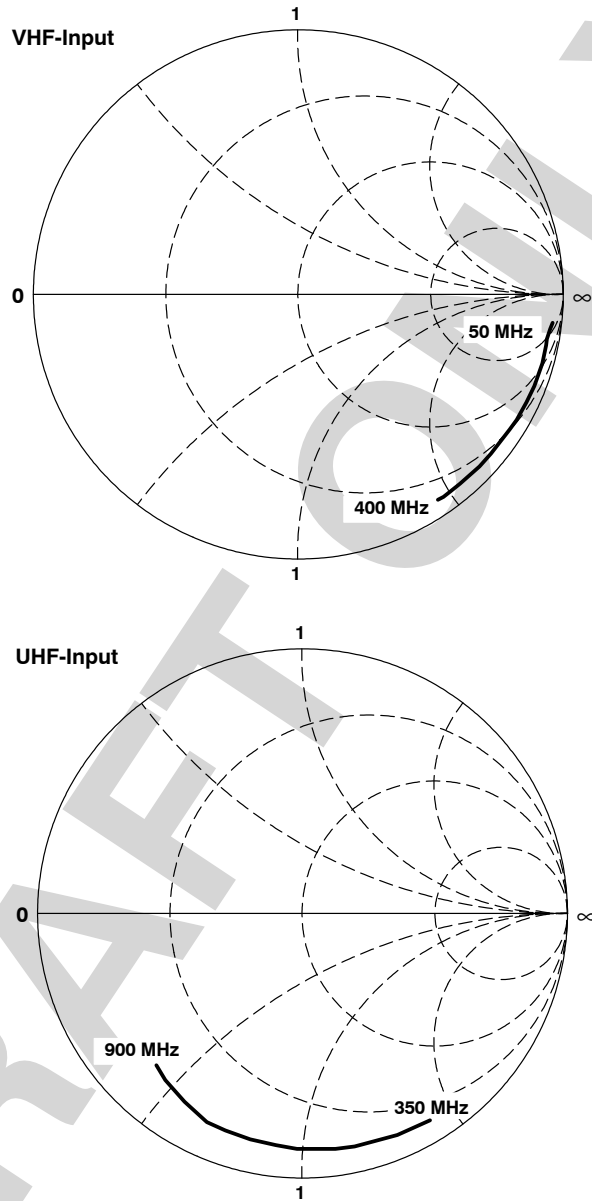
Figure 17. 1% Cross Modulation Distortion Measurement Circuit



APPLICATION INFORMATION

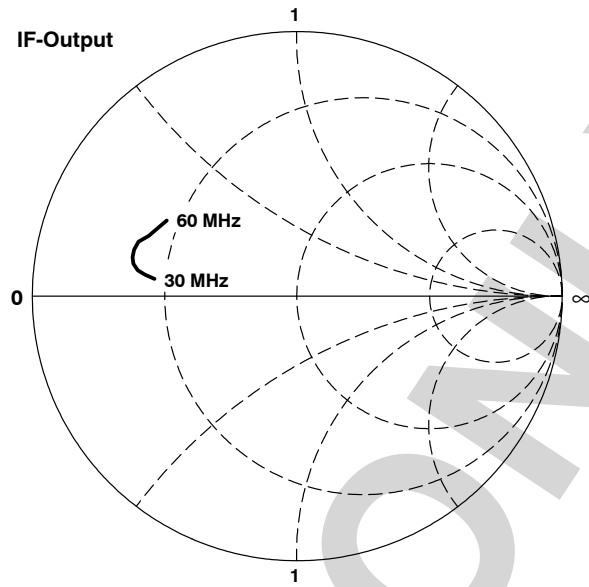
typical characteristics

S-parameter

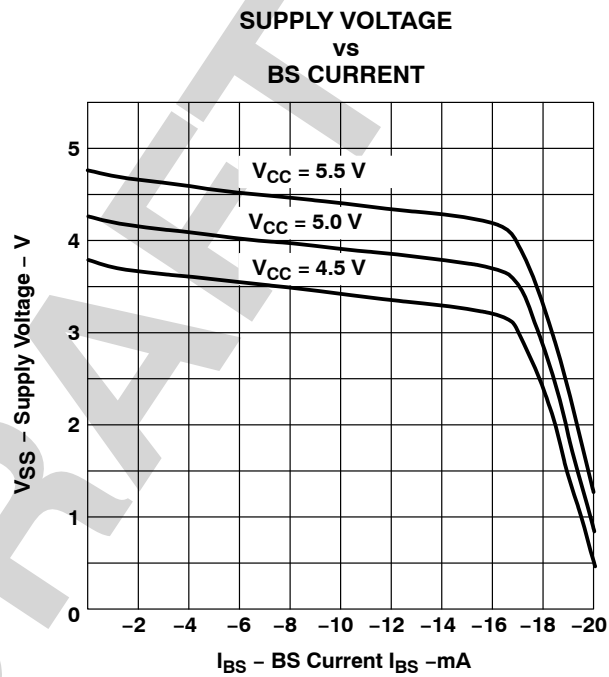


**APPLICATION INFORMATION**

**IF-output**



**bandswitch driver output voltage**



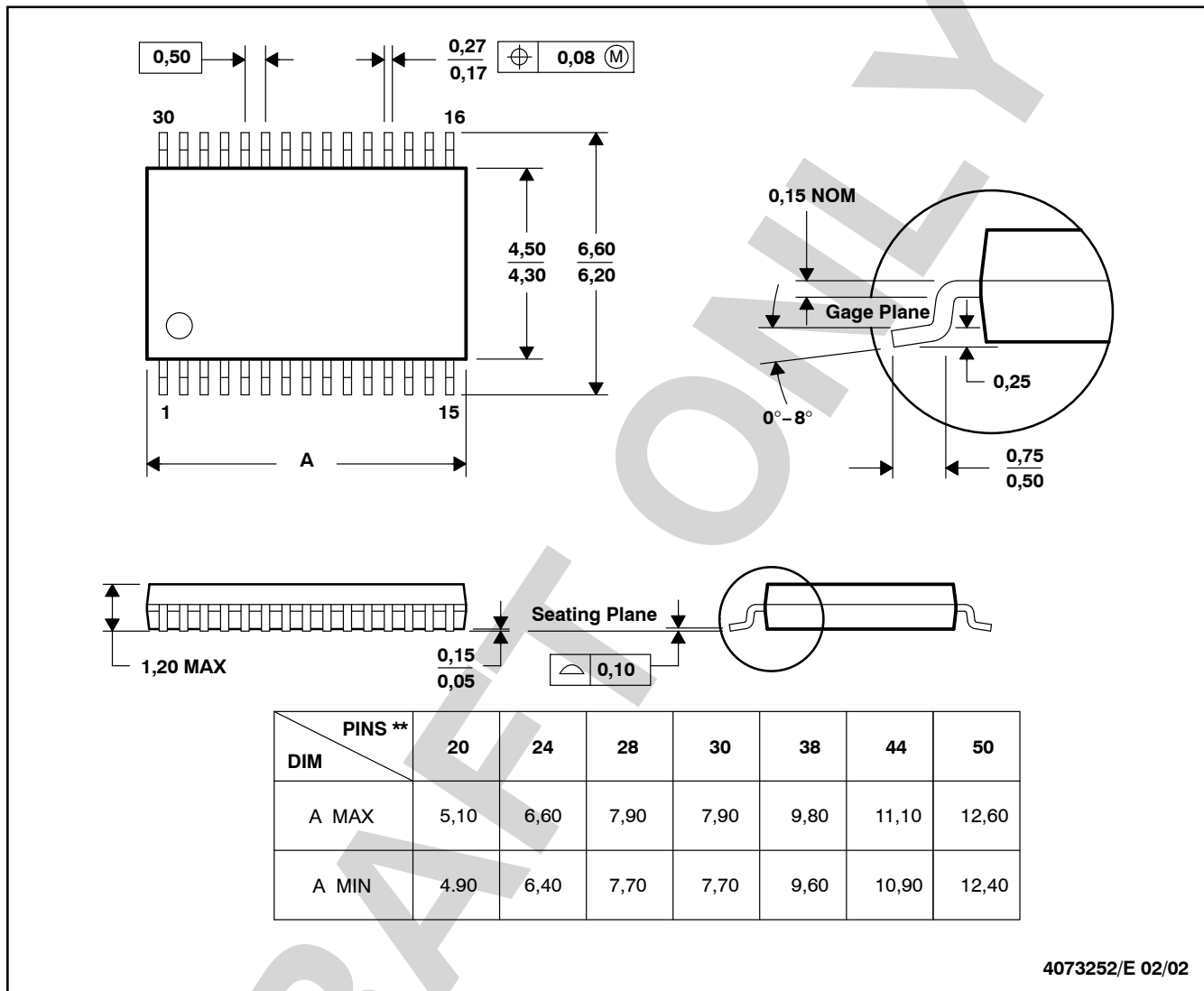
MECHANICAL DATA

DBT (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

The SN761678 tuner is encased in a thin shrink small outline package (TSSOP).

30 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion.  
 D. Falls within JEDEC MO-153

**IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

**Products**

Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>

**Applications**

Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
Broadband	<a href="http://www.ti.com/broadband">www.ti.com/broadband</a>
Digital Control	<a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a>
Military	<a href="http://www.ti.com/military">www.ti.com/military</a>
Optical Networking	<a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a>
Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
Telephony	<a href="http://www.ti.com/telephony">www.ti.com/telephony</a>
Video & Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
Wireless	<a href="http://www.ti.com/wireless">www.ti.com/wireless</a>

Mailing Address: Texas Instruments  
Post Office Box 655303 Dallas, Texas 75265

Copyright © 2003, Texas Instruments Incorporated



## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

### Products

Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>
DLP® Products	<a href="http://www.dlp.com">www.dlp.com</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>
Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>
OMAP Applications Processors	<a href="http://www.ti.com/omap">www.ti.com/omap</a>
Wireless Connectivity	<a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a>

### Applications

Automotive and Transportation	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
Communications and Telecom	<a href="http://www.ti.com/communications">www.ti.com/communications</a>
Computers and Peripherals	<a href="http://www.ti.com/computers">www.ti.com/computers</a>
Consumer Electronics	<a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>
Energy and Lighting	<a href="http://www.ti.com/energy">www.ti.com/energy</a>
Industrial	<a href="http://www.ti.com/industrial">www.ti.com/industrial</a>
Medical	<a href="http://www.ti.com/medical">www.ti.com/medical</a>
Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
Space, Avionics and Defense	<a href="http://www.ti.com/space-avionics-defense">www.ti.com/space-avionics-defense</a>
Video and Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>

### TI E2E Community

[e2e.ti.com](http://e2e.ti.com)